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September 2016

PCFFS15120AF Silicon Carbide Schottky Diode

Features

1200 V, 15 A

- Max Junction Temperature 175 °C
- · Avalanche Rated 145 mJ
- · High Surge Current Capacity
- · Positive Temperature Coefficient
- · Ease of Paralleling
- · No Reverse Recovery / No Forward Recovery

Applications

- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

Description

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material - Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size/cost. Its high reliability ensures robust operation during surge or over-voltage conditions

Die Information

Wafer Diameter 6 inch

• Die Size 2,730 x 2,730 μm (include S/L)

Metallization

 $\begin{array}{ccc} \cdot \mbox{ Top} & & \mbox{Ti / TiN / Al } 4 \mu m \\ \cdot \mbox{ Back} & & \mbox{Ti/ NiV /Ag} \end{array}$

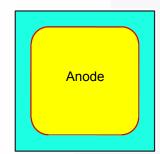
• Die Thickness Typ. $200 \mu m$

· Bonding Pad Size

• Anode $2150 \times 2150 \mu m$

• Recommended Wire Bond (Note 1)

· Anode 15mil × 2



Electrical Characteristics on Wafer T_C = 25°C unless otherwise noted

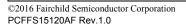
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V_R	Reverse Blocking Voltage	$I_R = 200 \mu A, T_C = 25 {}^{\circ}C$	1230	-	-	V
V _F	Forward Voltage	I _F = 15 A, T _C = 25 °C	1.22	-	1.723	V
I _R	Reverse Current	V _R = 1230 V, T _C = 25 °C	-	-	200	μΑ

Notes:

- 1. Based on TO-247 package of Fairchild
- 2. Tested 100% on wafer
- 3. -F: sawn-on-film frame packing based on wafer tested

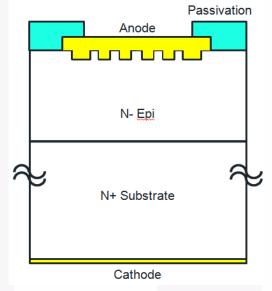
For Additional Product Information and Electrical Characteristics on Package

Refer to the FFSH30120ADN_F155 product datasheet



Die Layout (Dimension : µm, except S/L) 2650 Anode Passivation Area

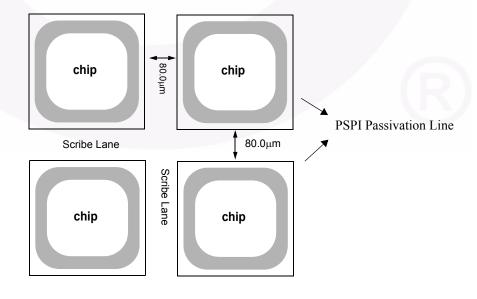
Cross Section



Passivation Information

- Passivation Material: Polyimide (PSPI)
- Passivation Type : Local Passivation
- Passivation Thickness: 90KA

The Configuration of chips (Based on 6 inch wafer)







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